MCP73853/55

USB Compatible Li-Ion/Li-Polymer Charge Management Controllers

Features

- Linear Charge Management Controllers
  - Integrated Pass Transistor
  - Integrated Current Sense
  - Reverse Blocking Protection
- High-Accuracy Preset Voltage Regulation: ± 0.5%
- Two Selectable Voltage Regulation Options:
  - 4.1V, 4.2V
- Programmable Charge Current
- USB Compatible Charge Current Settings
- Programmable Safety Charge Timers
- Preconditioning of Deeply Depleted Cells
- Automatic End-of-Charge Control
- Optional Continuous Cell Temperature Monitoring

MCP73853

- Charge Status Output for Direct LED Drive
- Fault Output for Direct LED Drive

MCP73853

- Automatic Power-Down
- Thermal Regulation
- Temperature Range: -40°C to +85°C

- Packaging:
  - 16-Lead, 4x4 mm QFN **(MCP73853)**
  - 10-Lead, 3x3 mm DFN **(MCP73855)**

Applications

- Lithium-Ion/Lithium-Polymer Battery Chargers
- Personal Data Assistants (PDAs)
- Cellular Telephones
- Hand-Held Instruments
- Cradle Chargers
- Digital Cameras
- MP3 Players
- Bluetooth Headsets
- USB Chargers

Description

The MCP7385X devices are highly-advanced, linear charge management controllers, for use in space-limited, cost-sensitive applications. The MCP73853 combines high-accuracy constant-voltage, constant-current regulation, cell preconditioning, cell temperature monitoring, advanced safety timers, automatic charge termination, internal current sensing, reverse blocking protection and charge status and fault indication in a space-saving 16-lead, 4x4 QFN package.

The MCP73855 employs all the features of the MCP73853, with the exception of the cell temperature monitor and one status output. The MCP73855 is offered in a space-saving 10-lead, 3x3 DFN package.

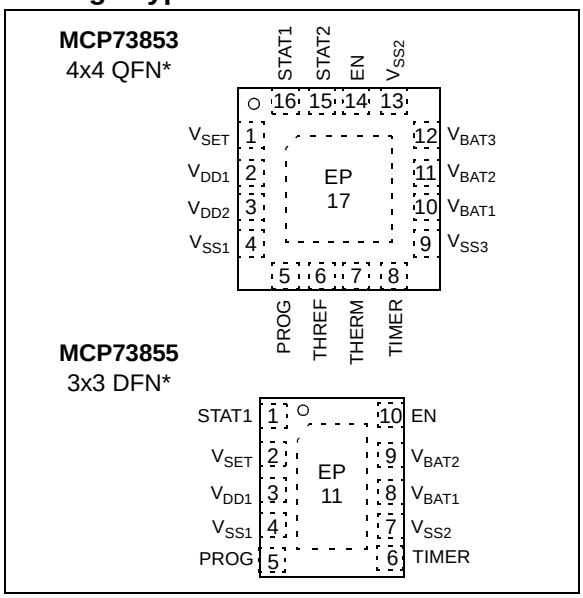
The MCP73853 and MCP73855 are designed specifically for USB applications, adhering to all the specifications governing the USB power bus.

The MCP7385X devices provide two selectable voltage regulation options (4.1V or 4.2V) for use with either coke or graphite anodes.

The MCP7385X devices provide complete, fully-functional, charge management solutions, operating with an input voltage range of 4.5V to 5.5V.

The MCP7385X devices are fully specified over the ambient temperature range of -40°C to +85°C.

Package Types



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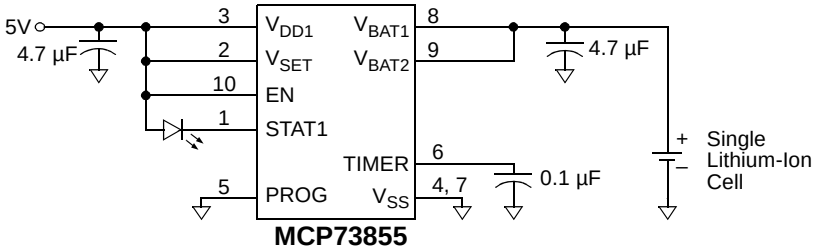
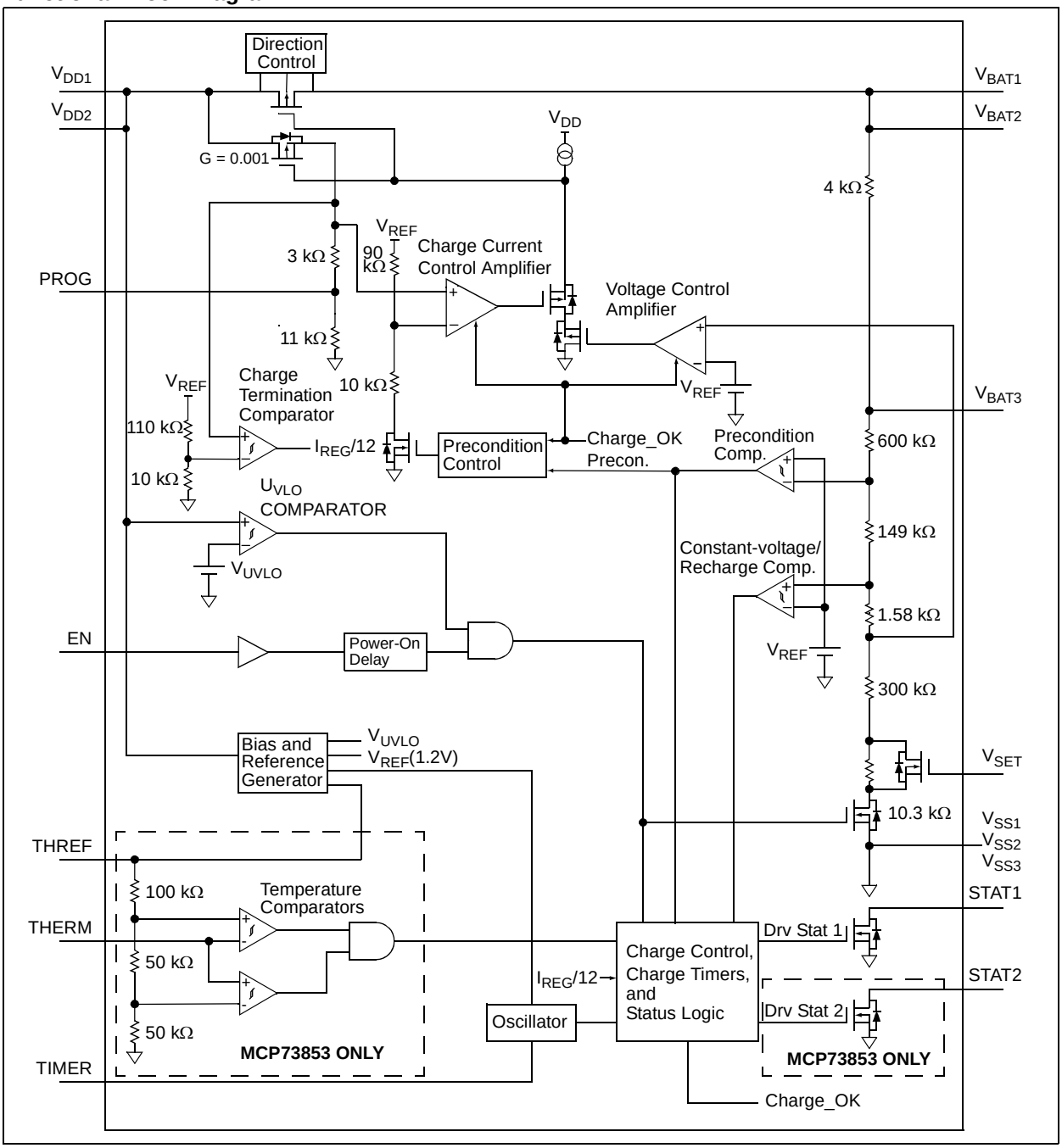
Typical Application

400 mA Lithium-Ion Battery Charger



Functional Block Diagram



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1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings*

$V_{DD1,2}$ 6.5V

All Inputs and Outputs w.r.t. V_{SS} .....-0.3 to (V_{DD} + 0.3)V

Maximum Junction Temperature, T_J .....Internally Limited

Storage temperature .....-65°C to +150°C

ESD protection on all pins:

Human Body Model (1.5kW in Series with 100pF) ....≥ 4 kV

Machine Model (200pF, No Series Resistance) 400V

***Notice:** Stresses above those listed under "Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

Electrical Specifications: Unless otherwise indicated, all limits apply for V_{DD} = [V_{REG}(Typ) + 0.3V] to 5.5V, T_A = -40°C to 85°C. Typical values are at +25°C, V_{DD} = [V_{REG} (Typ) + 1.0V]

Parameters	Sym	Min	Typ	Max	Units	Conditions
Supply Input						
Supply Voltage	V_{DD}	4.5	—	5.5	V	
Supply Current	I_{SS}	—	0.28	4	µA	Disabled
		—	0.83	4	mA	Operating
UVLO Start Threshold	V_{START}	4.25	4.45	4.65	V	V_{DD} Low-to-High
UVLO Stop Threshold	V_{STOP}	4.20	4.40	4.55	V	V_{DD} High-to-Low
Voltage Regulation (Constant-Voltage Mode)						
Regulated Output Voltage	V_{REG}	4.079	4.1	4.121	V	$V_{SET} = V_{SS}$
		4.179	4.2	4.221	V	$V_{SET} = V_{DD}$
						V_{DD} = [V_{REG}(Typ) + 1V], I_{OUT} = 10 mA, T_A = -5°C to +55°C
Line Regulation	$\lvert(\Delta V_{BAT}/V_{BAT})\rvert / \Delta V_{DD}$	—	0.020	0.25	%/V	V_{DD} = [V_{REG}(Typ) + 1V] to 5.5V I_{OUT} = 10 mA
Load Regulation	$\lvert\Delta V_{BAT}/V_{BAT}\rvert$	—	0.022	0.25	%	I_{OUT} = 10 mA to 150 mA V_{DD} = [V_{REG}(Typ) + 1V]
Supply Ripple Attenuation	PSRR	—	50	—	dB	I_{OUT} = 10 mA, 10 Hz to 1 kHz
		—	26	—	dB	I_{OUT} = 10 mA, 10 Hz to 10 kHz
		—	24	—	dB	I_{OUT} = 10 mA, 10 Hz to 1 MHz
Output Reverse-Leakage Current	$I_{DISCHARGE}$	—	0.24	1	µA	$V_{DD} < V_{BAT} = V_{REG}$(Typ)
Current Regulation (Fast Charge Constant-Current Mode)						
Fast Charge Current Regulation	I_{REG}	70	85	100	mA	PROG = OPEN
		325	400	475	mA	PROG = V_{SS}
						T_A = -5°C to +55°C
Preconditioning Current Regulation (Trickle Charge Constant-Current Mode)						
Precondition Current Regulation	I_{PREG}	5	9	15	mA	PROG = OPEN
		25	40	75	mA	PROG = V_{SS}
						T_A = -5°C to +55°C
Precondition Threshold Voltage	V_{PTH}	2.70	2.80	2.90	V	$V_{SET} = V_{SS}$
		2.75	2.85	2.95	V	$V_{SET} = V_{DD}$
						V_{BAT} Low-to-High

DC CHARACTERISTICS (Continued)

Electrical Specifications: Unless otherwise indicated, all limits apply for V_{DD} = [V_{REG}(Typ) + 0.3V] to 5.5V, T_A = -40°C to 85°C. Typical values are at +25°C, V_{DD} = [V_{REG} (Typ) + 1.0V]

Parameters	Sym	Min	Typ	Max	Units	Conditions
Charge Termination						
Charge Termination Current	I_{TERM}	3.7 18	6.5 32	9.3 46	mA mA	PROG = OPEN PROG = V_{SS} T_A = -5°C to +55°C
Automatic Recharge						
Recharge Threshold Voltage	V_{RTH}	V_{REG} – 300mV	V_{REG} – 200mV	V_{REG} – 100mV	V	V_{BAT} High-to-Low
Thermistor Reference - MCP73853						
Thermistor Reference Output Voltage	V_{THREF}	2.475	2.55	2.625	V	T_A = 25°C, V_{DD} = V_{REG}(Typ) + 1V, I_{THREF} = 0 mA
Thermistor Reference Source Current	I_{THREF}	200	—	—	µA	
Thermistor Reference Line Regulation	$\lvert(\Delta V_{THREF}/V_{THREF})\rvert/\Delta V_{DD}$	—	0.05	0.25	%/V	V_{DD} = [V_{REG} (Typ) + 1V] to 5.5V
Thermistor Reference Load Regulation	$\lvert\Delta V_{THREF}/V_{THREF}\rvert$		0.02	0.10	%	I_{THREF} = 0 mA to 0.20 mA
Thermistor Comparator - MCP73853						
Upper Trip Threshold	V_{T1}	1.18	1.25	1.32	V	
Upper Trip Point Hysteresis	V_{T1HYS}	—	-50	—	mV	
Lower Trip Threshold	V_{T2}	0.59	0.62	0.66	V	
Lower Trip Point Hysteresis	V_{T2HYS}	—	80	—	mV	
Input Bias Current	I_{BIAS}	—	—	2	µA	
Status Indicator – STAT1, STAT2						
Sink Current	I_{SINK}	4	8	12	mA	
Low Output Voltage	V_{OL}	—	200	400	mV	I_{SINK} = 1 mA
Input Leakage Current	I_{LK}	—	0.01	1	µA	I_{SINK} = 0 mA, $V_{STAT1,2}$ = 5.5V
Enable Input						
Input High Voltage Level	V_{IH}	1.4	—	—	V	
Input Low Voltage Level	V_{IL}	—	—	0.8	V	
Input Leakage Current	I_{LK}	—	0.01	1	µA	V_{ENABLE} = 5.5V
Thermal Shutdown						
Die Temperature	T_{SD}	—	155	—	°C	
Die Temperature Hysteresis	T_{SDHYS}	—	10	—	°C	

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AC CHARACTERISTICS

Electrical Specifications: Unless otherwise indicated, all limits apply for V_{DD} = [V_{REG} (Typ) + 0.3V] to 5.5V, T_A = -40°C to 85°C. Typical values are at +25°C, V_{DD} = [V_{REG} (Typ) + 1.0V]						
Parameters	**Sym**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
UVLO Start Delay	t_{START}	—	—	5	ms	V_{DD} Low-to-High
Current Regulation						
Transition Time Out of Preconditioning	t_{DELAY}	—	—	1	ms	$V_{BAT} < V_{PTH}$ to $V_{BAT} > V_{PTH}$
Current Rise Time Out of Preconditioning	t_{RISE}	—	—	1	ms	I_{OUT} Rising to 90% of I_{REG}
Fast Charge Safety Timer Period	t_{FAST}	1.1	1.5	1.9	Hours	C_{TIMER} = 0.1 µF
Preconditioning Current Regulation						
Preconditioning Charge Safety Timer Period	t_{PRECON}	45	60	75	Minutes	C_{TIMER} = 0.1 µF
Charge Termination						
Elapsed Time Termination Period	t_{TERM}	2.2	3	3.8	Hours	C_{TIMER} = 0.1 µF
Status Indicators						
Status Output Turn-off	t_{OFF}	—	—	200	µs	I_{SINK} = 1 mA to 0 mA
Status Output Turn-on	t_{ON}	—	—	200	µs	I_{SINK} = 0 mA to 1 mA

TEMPERATURE SPECIFICATIONS

Electrical Specifications: Unless otherwise indicated, all limits apply for V_{DD} = [V_{REG} (Typ) + 0.3V] to 5.5. Typical values are at +25°C, V_{DD} = [V_{REG} (Typ) + 1.0V]						
Parameters	**Sym**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
Temperature Ranges						
Specified Temperature Range	T_A	-40	—	+85	°C	
Operating Temperature Range	T_J	-40	—	+125	°C	
Storage Temperature Range	T_A	-65	—	+150	°C	
Thermal Package Resistances						
Thermal Resistance, 16-L, 4mm x 4mm QFN	θ_{JA}	—	37	—	°C/W	4-Layer JC51-7 Standard Board, Natural Convection
Thermal Resistance, 10-L, 3mm x 3mm DFN	θ_{JA}	—	51	—	°C/W	4-Layer JC51-7 Standard Board, Natural Convection

2.0 TYPICAL PERFORMANCE CURVES

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

NOTE: Unless otherwise indicated, V_{DD} = [V_{REG}(Typ) + 1V], I_{OUT} = 10 mA and T_A= +25°C.

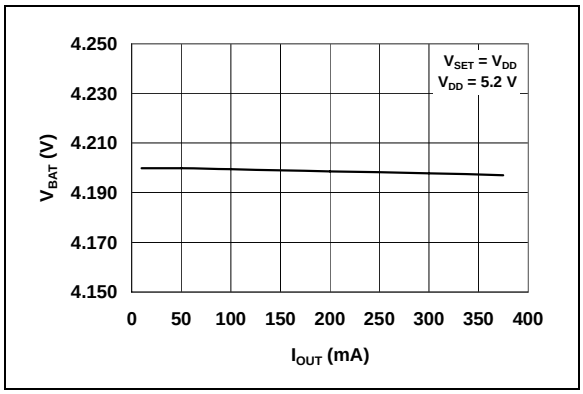

FIGURE 2-1: *Battery Regulation Voltage (V_{BAT}) vs. Charge Current (I_{OUT}).*

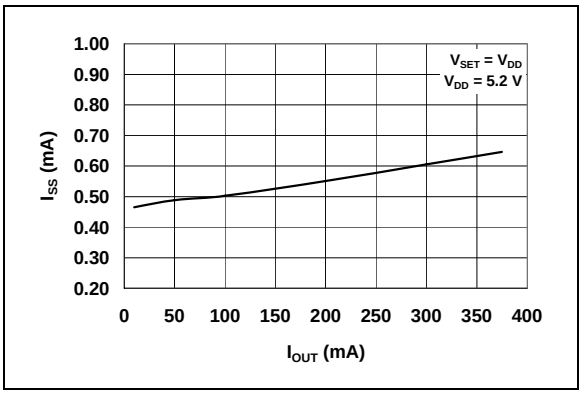

FIGURE 2-4: *Supply Current (I_{SS}) vs. Charge Current (I_{OUT}).*

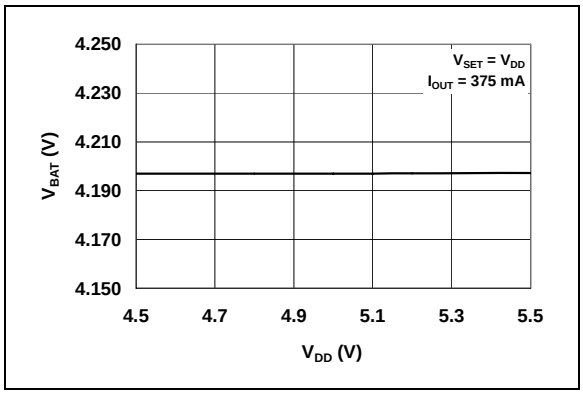

FIGURE 2-2: *Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}).*

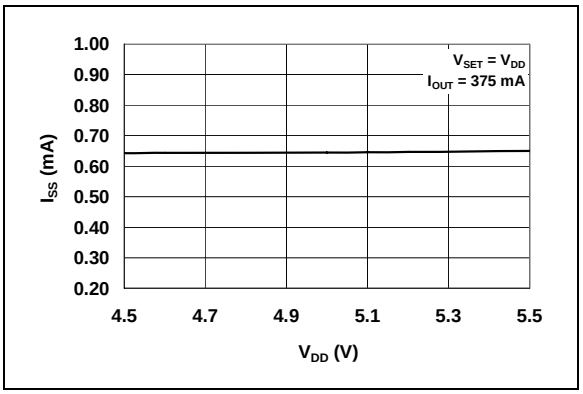

FIGURE 2-5: *Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).*

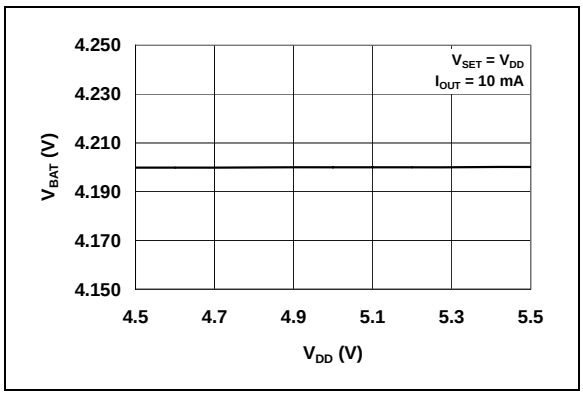

FIGURE 2-3: *Battery Regulation Voltage (V_{BAT}) vs. Supply Voltage (V_{DD}).*

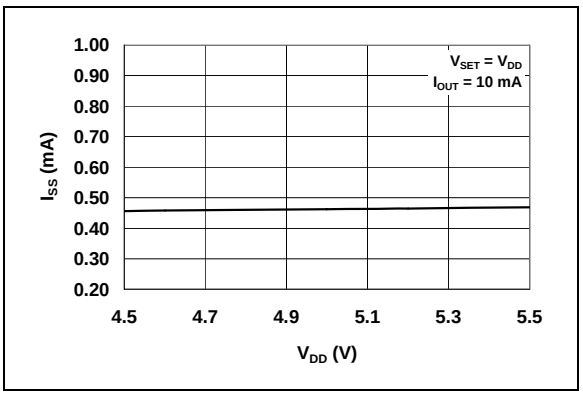

FIGURE 2-6: *Supply Current (I_{SS}) vs. Supply Voltage (V_{DD}).*

NOTE: Unless otherwise indicated, V_{DD} = [V_{REG}(Typ) + 1V], I_{OUT} = 10 mA and T_A= +25°C.

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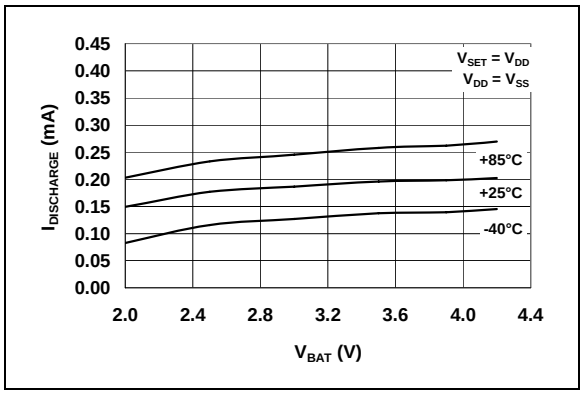

FIGURE 2-7: *Output Leakage Current ($I_{DISCHARGE}$) vs. Battery Voltage (V_{BAT}).*

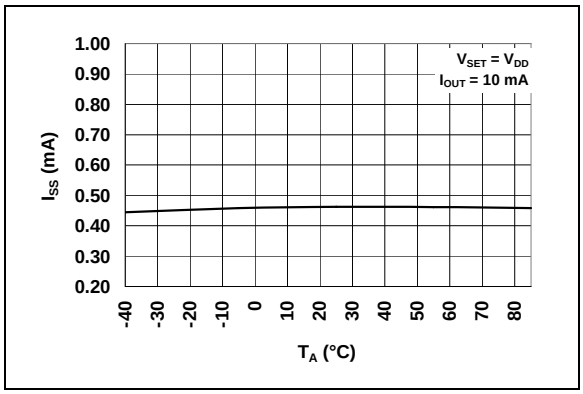

FIGURE 2-10: *Supply Current (I_{SS}) vs. Ambient Temperature (T_A).*

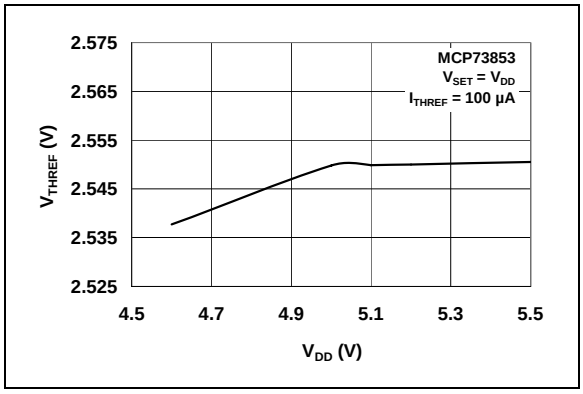

FIGURE 2-8: *Thermistor Reference Voltage (V_{THREF}) vs. Supply Voltage (V_{DD}).*

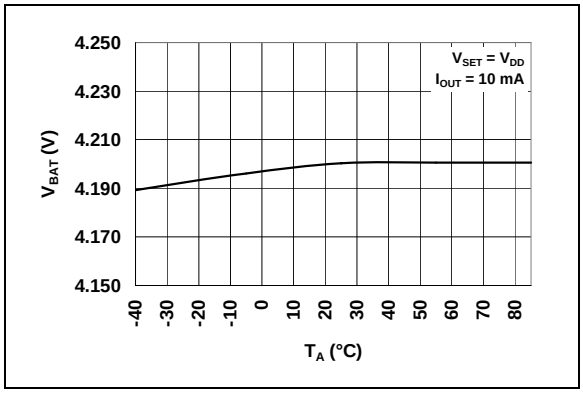

FIGURE 2-11: *Battery Regulation Voltage (V_{BAT}) vs. Ambient Temperature (T_A).*

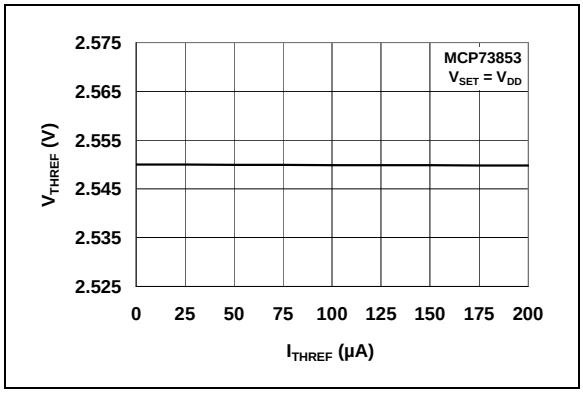

FIGURE 2-9: *Thermistor Reference Voltage (V_{THREF}) vs. Thermistor Bias Current (I_{THREF}).*

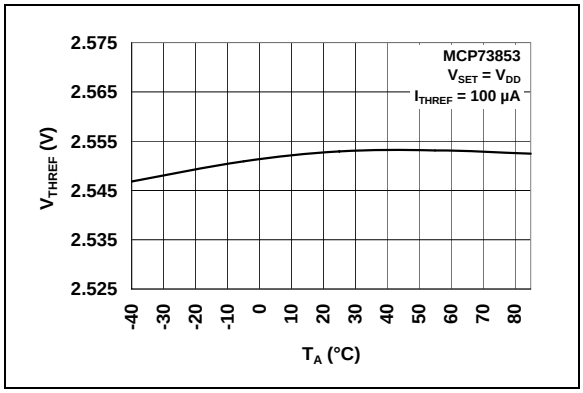

FIGURE 2-12: *Thermistor Reference Voltage (V_{THREF}) vs. Ambient Temperature (T_A).*

NOTE: Unless otherwise indicated, V_{DD} = [V_{REG}(Typ) + 1V], I_{OUT} = 10 mA and T_A= +25°C.

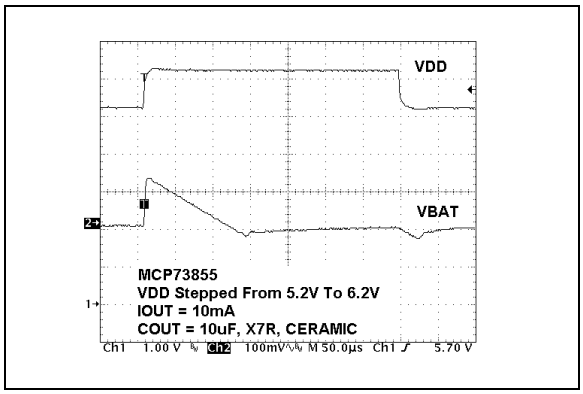

FIGURE 2-13: *Line Transient Response.*

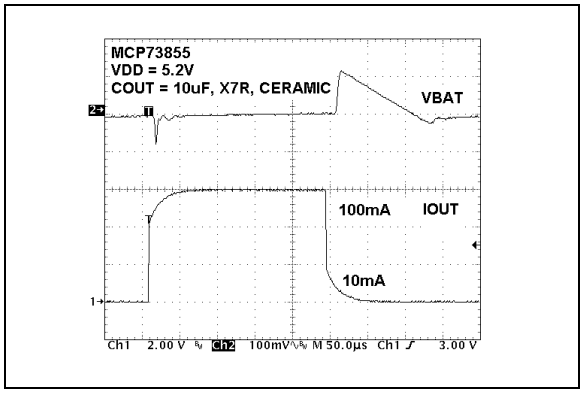

FIGURE 2-14: *Load Transient Response.*

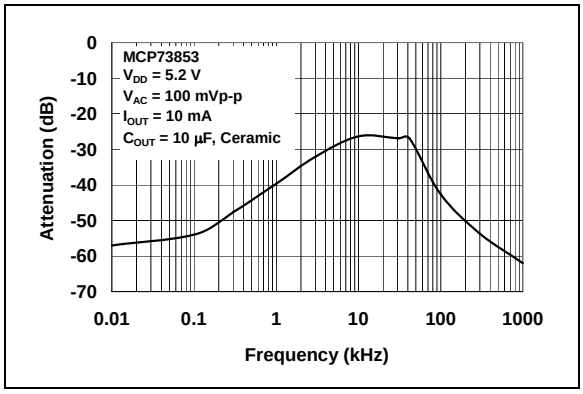

FIGURE 2-15: *Power Supply Ripple Rejection.*

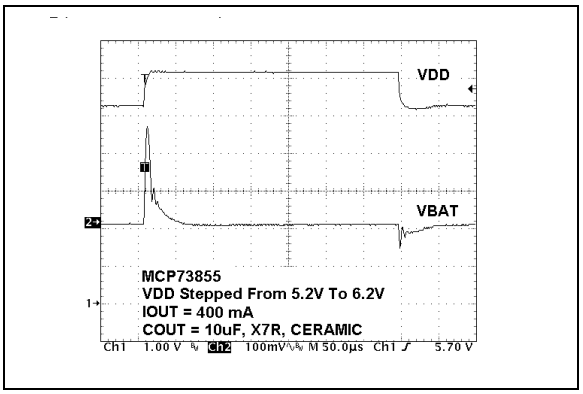

FIGURE 2-16: *Line Transient Response.*

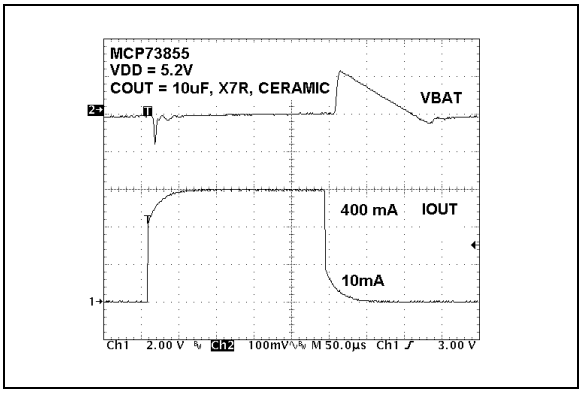

FIGURE 2-17: *Load Transient Response.*

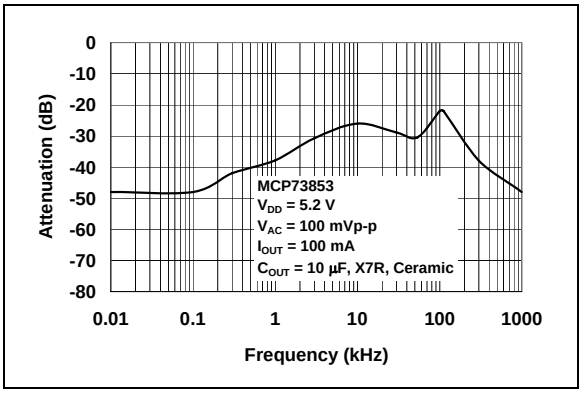

FIGURE 2-18: *Power Supply Ripple Rejection.*

NOTE: Unless otherwise indicated, V_{DD} = [V_{REG}(Typ) + 1V], I_{OUT} = 10 mA, and T_A= +25°C.

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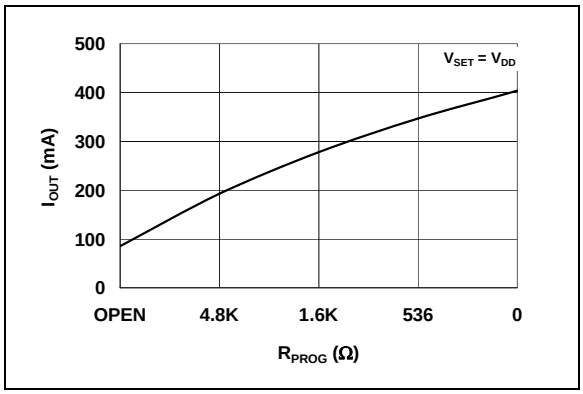

FIGURE 2-19: *Charge Current (I_{OUT}) vs. Programming Resistor (R_{PROG}).*

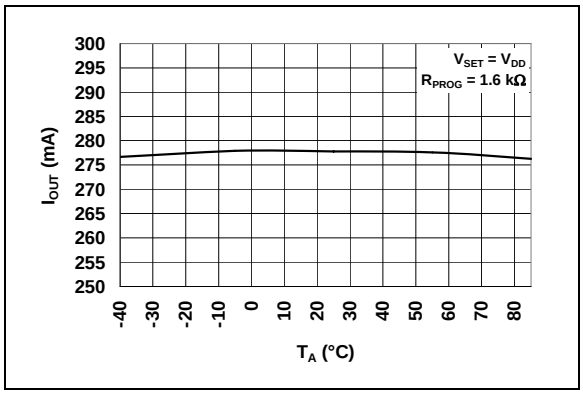

FIGURE 2-20: *Charge Current (I_{OUT}) vs. Ambient Temperature (T_A).*

3.0 PIN DESCRIPTION

The descriptions of the pins are listed in Table 3-1.

TABLE 3-1: PIN FUNCTION TABLE

MCP73853	MCP73855	Sym	Description
1	2	V_{SET}	Voltage Regulation Selection
2	3	V_{DD1}	Battery Management Input Supply
3	—	V_{DD2}	Battery Management Input Supply
4	4	V_{SS1}	Battery Management 0V Reference
5	5	PROG	Current Regulation Set
6	—	THREF	Cell Temperature Sensor Bias
7	—	THERM	Cell Temperature Sensor Input
8	6	TIMER	Timer Set
9	—	V_{SS3}	Battery Management 0V Reference
10	8	V_{BAT1}	Battery Charge Control Output
11	9	V_{BAT2}	Battery Charge Control Output
12	—	V_{BAT3}	Battery Voltage Sense
13	7	V_{SS2}	Battery Management 0V Reference
14	10	EN	Logic Enable
15	—	STAT2	Fault Status Output
16	1	STAT1	Charge Status Output

3.1 Voltage Regulation Selection (V_{SET})

Connect to V_{SS} for 4.1V regulation voltage. Connect to V_{DD} for 4.2V regulation voltage.

3.2 Battery Management Input Supply (V_{DD1}, V_{DD2})

A supply voltage of [V_{REG}(Typ) + 0.3V] to 5.5V is recommended. Bypass to V_{SS} with a minimum of 4.7 µF.

3.3 Battery Management 0V Reference (V_{SS1}, V_{SS2}, V_{SS3})

Connect to negative terminal of battery.

3.4 Current Regulation Set (PROG)

Preconditioning, fast and termination currents are scaled by placing a resistor from PROG to V_{SS}.

3.5 Cell Temperature Sensor Bias (THREF)

THREF is a voltage reference to bias external thermistor for continuous cell temperature monitoring and pre-qualification.

3.6 Cell Temperature Sensor Input (THERM)

Input for an external thermistor for continuous cell-temperature monitoring and prequalification. Connect to THREF/3 to disable temperature sensing.

3.7 Timer Set (TIMER)

All safety timers are scaled by C_{TIMER}/0.1 µF.

3.8 Battery Charge Control Output (V_{BAT1}, V_{BAT2})

Connect to positive terminal of battery. Drain terminal of internal P-channel MOSFET pass transistor. Bypass to V_{SS} with a minimum of 4.7 µF to ensure loop stability when the battery is disconnected.

3.9 Battery Voltage Sense (V_{BAT3})

Voltage sense input. Connect to positive terminal of battery. A precision internal resistor divider regulates the final voltage on this pin to V_{REG}.

3.10 Logic Enable (EN)

Input to force charge termination, initiate charge, clear faults or disable automatic recharge.

3.11 Fault Status Output (STAT2)

Current-limited, open-drain drive for direct connection to a LED for charge status indication. Alternatively, a pull-up resistor can be applied for interfacing to a host microcontroller.

3.12 Charge Status Output (STAT1)

Current-limited, open-drain drive for direct connection to a LED for charge status indication. Alternatively, a pull-up resistor can be applied for interfacing to a host microcontroller.

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4.0 DEVICE OVERVIEW

The MCP7385X devices are highly advanced linear charge management controllers. For more information, refer to the **"Functional Block Diagram"** on page 2. Figure 4-2 depicts the operational flow algorithm from charge initiation to completion and automatic recharge.

4.1 Charge Qualification and Preconditioning

Upon insertion of a battery, or application of an external supply, the MCP7385X devices automatically perform a series of safety checks to qualify the charge. The input source voltage must be above the Undervoltage Lock-out (UVLO) threshold, the enable pin must be above the logic high level, and the cell temperature monitor must be within the upper and lower thresholds (MCP73853 only). The qualification parameters are continuously monitored, with any deviation beyond the limits automatically suspending, or terminating, the charge cycle. The input voltage must deviate below the UVLO stop threshold for at least one clock period to be considered valid.

Once the qualification parameters have been met, the MCP7385X devices initiate a charge cycle. The charge status output is pulled low throughout the charge cycle (see Tables 5-1 and 5-2 for charge status outputs). If the battery voltage is below the preconditioning threshold (V_{PTH}), the MCP7385X devices precondition the battery with a trickle charge. The preconditioning current is set to approximately 10% of the fast charge regulation current. The preconditioning trickle charge safely replenishes deeply depleted cells and minimizes heat dissipation during the initial charge cycle. If the battery voltage has not exceeded the preconditioning threshold before the preconditioning timer has expired, a fault is indicated and the charge cycle is terminated.

4.2 Constant Current Regulation – Fast Charge

Preconditioning ends and fast charging begins when the battery voltage exceeds the preconditioning threshold. Fast charge regulates to a constant current (I_{REG}), which is set via an external resistor connected to the PROG pin. Fast charge continues until either the battery voltage reaches the regulation voltage (V_{REG}) or the fast charge timer expires; in which case, a fault is indicated and the charge cycle is terminated.

4.3 Constant Voltage Regulation

When the battery voltage reaches the regulation voltage (V_{REG}), constant voltage regulation begins. The MCP7385X devices monitor the battery voltage at the V_{BAT} pin. This input is tied directly to the positive terminal of the battery. The MCP7385X devices select the voltage regulation value based on the state of V_{SET}. With V_{SET} tied to V_{SS}, the MCP7385X devices regulate to 4.1V. With V_{SET} tied to V_{DD}, the MCP7385X devices regulate to 4.2V.

4.4 Charge Cycle Completion and Automatic Recharge

The MCP7385X devices monitor the charging current during the Constant-voltage Regulation mode. The charge cycle is considered complete when either the charge current has diminished below approximately 7% of the regulation current (I_{REG}), or the elapsed timer has expired.

The MCP7385X devices automatically begin a new charge cycle when the battery voltage falls below the recharge threshold (V_{RTH}), assuming all the qualification parameters are met.

4.5 Thermal Regulation

The MCP7385X devices limit the charge current based on the die temperature. Thermal regulation optimizes the charge cycle time while maintaining device reliability. If thermal regulation is entered, the timer is automatically slowed down to ensure that a charge cycle will not terminate prematurely. Figure 4-1 depicts the thermal regulation.

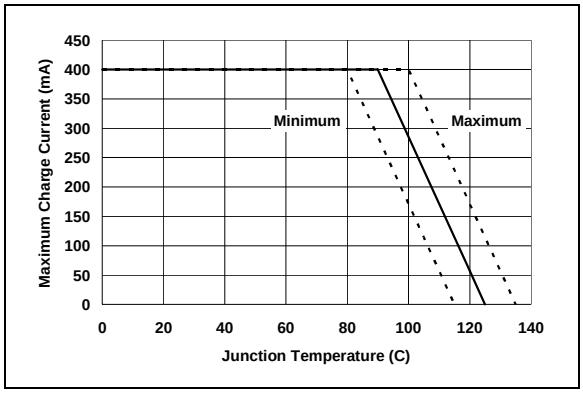

FIGURE 4-1: *Typical Maximum Charge Current vs. Junction Temperature.*

4.6 Thermal Shutdown

The MCP7385X devices suspend charge if the die temperature exceeds 155°C. Charging will resume when the die temperature has cooled by approximately 10°C. The thermal shutdown is a secondary safety feature in the event that there is a failure within the thermal regulation circuitry.

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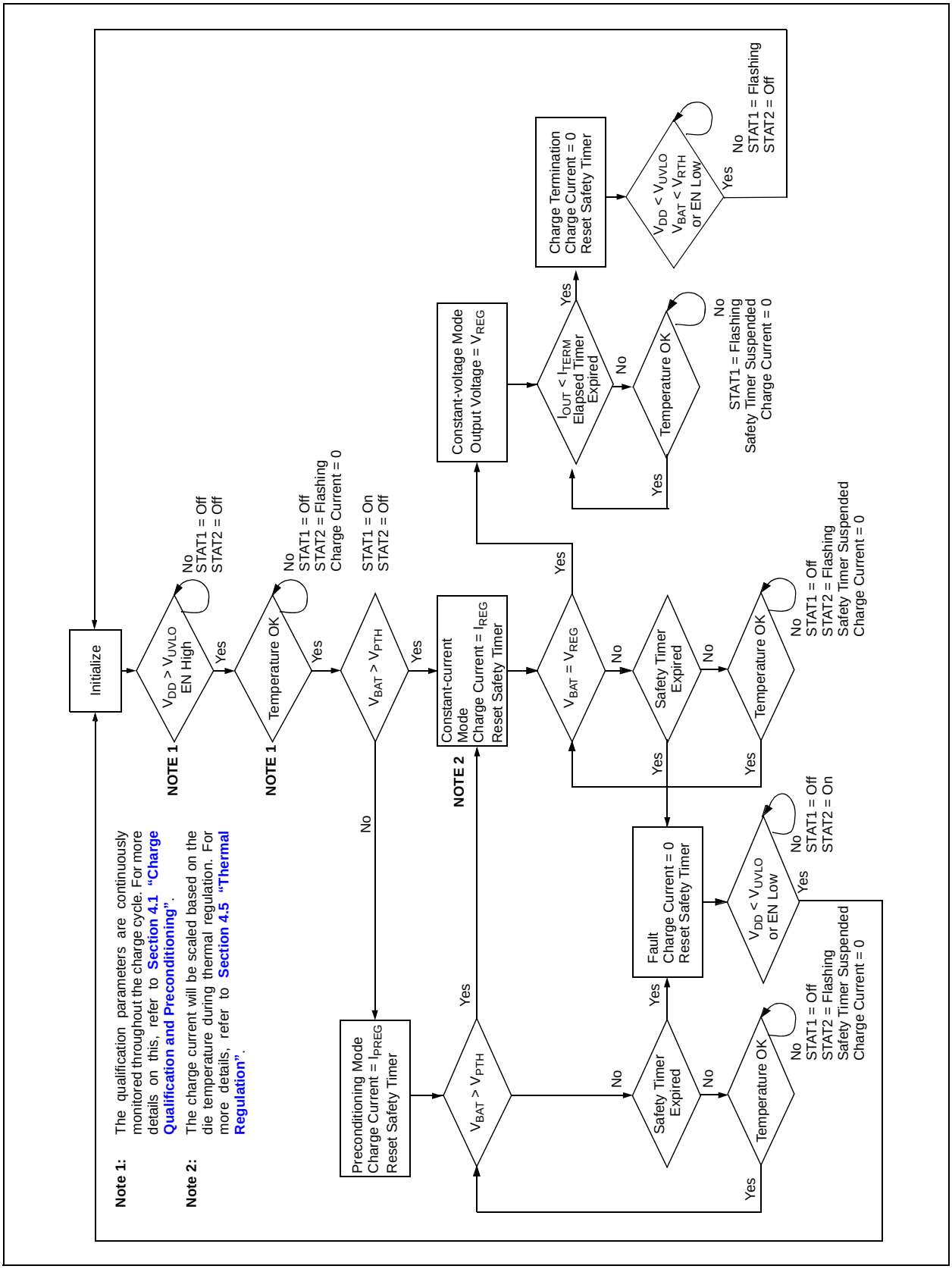

FIGURE 4-2: *Operational Flow Algorithm.*

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5.0 DETAILED DESCRIPTION

5.1 Analog Circuitry

5.1.1 BATTERY MANAGEMENT INPUT SUPPLY (V_{DD1}, V_{DD2})

The V_{DD} input is the input supply to the MCP7385X devices. The MCP7385X devices automatically enter a power-down mode if the voltage on the V_{DD} input falls below the UVLO voltage (V_{STOP}). This feature prevents draining the battery pack when the V_{DD} supply is not present.

5.1.2 PROG INPUT

Fast charge current regulation can be scaled by placing a programming resistor (R_{PROG}) from the PROG input to V_{SS}. Connecting the PROG input to V_{SS} allows for a maximum fast charge current of 400 mA, typically. The minimum fast charge current is 85 mA (Typ) and is set by letting the PROG input float. Equation 5-1 calculates the value for R_{PROG}.

EQUATION 5-1:

$$R_{PROG} = \frac{13.32 - 33.3 \times I_{REG}}{14.1 \times I_{REG} - 1.2}$$

Where:

I_{REG} is the desired fast charge current in amps

R_{PROG} is in kilohms.

The preconditioning trickle charge current and the charge termination current are scaled to approximately 10% and 7% of I_{REG}, respectively.

5.1.3 CELL TEMPERATURE SENSOR BIAS (THREF)

A 2.55V voltage reference is provided to bias an external thermistor for continuous cell temperature monitoring and prequalification. A ratiometric window comparison is performed at threshold levels of $V_{THREF}/2$ and $V_{THREF}/4$.

5.1.4 CELL TEMPERATURE SENSOR INPUT (THERM)

The MCP73853 continuously monitors temperature by comparing the voltage between the THERM input and V_{SS} with the upper and lower temperature thresholds. A negative or positive temperature coefficient, NTC or PTC thermistor, and an external voltage divider typically develop this voltage. The temperature-sensing circuit has its own reference, to which it performs a ratiometric comparison. Therefore, it is immune to fluctuations in the supply input (V_{DD}). The temperature-sensing circuit is removed from the system when V_{DD} is not applied, eliminating additional discharge of the battery pack.

Figure 6-1 depicts a typical application circuit with connection of the THERM input. The resistor values of R_{T1} and R_{T2} are calculated with the following equations:

For NTC thermistors:

$$R_{T1} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{COLD} - R_{HOT}}$$

$$R_{T2} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{COLD} - 3 \times R_{HOT}}$$

For PTC thermistors:

$$R_{T1} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{HOT} - R_{COLD}}$$

$$R_{T2} = \frac{2 \times R_{COLD} \times R_{HOT}}{R_{HOT} - 3 \times R_{COLD}}$$

Where:

R_{COLD} and R_{HOT} are the thermistor resistance values at the temperature window of interest.

Applying a voltage equal to $V_{THREF}/3$ to the THERM input disables temperature monitoring.

5.1.5 TIMER SET INPUT (TIMER)

The TIMER input programs the period of the safety timers by placing a timing capacitor (C_{TIMER}) between the TIMER input pin and V_{SS}. Three safety timers are programmed via the timing capacitor.

The preconditioning safety timer period:

$$t_{PRECON} = \frac{C_{TIMER}}{0.1\mu F} \times 1.0 Hours$$

The fast charge safety timer period:

$$t_{FAST} = \frac{C_{TIMER}}{0.1\mu F} \times 1.5 Hours$$

And, the elapsed time termination period:

$$t_{TERM} = \frac{C_{TIMER}}{0.1\mu F} \times 3.0 Hours$$

The preconditioning timer starts after qualification and resets when the charge cycle transitions to the constant-current, fast charge phase. The fast charge timer and the elapsed timer start after the MCP7385X devices transition from preconditioning. The fast charge timer resets when the charge cycle transitions to the Constant-voltage mode. The elapsed timer will expire and terminate the charge if the sensed current does not diminish below the termination threshold.

During thermal regulation, the timer is slowed down proportional to the charge current.

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5.1.6 BATTERY VOLTAGE SENSE (V_{BAT3})

The MCP73853 monitors the battery voltage at the V_{BAT3} pin. This input is tied directly to the positive terminal of the battery pack.

5.1.7 BATTERY CHARGE CONTROL OUTPUT (V_{BAT1}, V_{BAT2})

The battery charge control output is the drain terminal of an internal P-channel MOSFET. The MCP7385X devices provide constant-current and constant-voltage regulation to the battery pack by controlling this MOSFET in the linear region. The battery charge control output should be connected to the positive terminal of the battery pack.

5.2 Digital Circuitry

5.2.1 CHARGE STATUS OUTPUTS (STAT1,STAT2)

Two status outputs provide information on the state of charge for the MCP73853. One status output provides information on the state of charge for the MCP73855. The current-limited, open-drain outputs can be used to illuminate external LEDs. Optionally, a pull-up resistor can be used on the output for communication with a host microcontroller. Table 5-1 and Table 5-2 summarize the state of the status outputs during a charge cycle for the MCP73853 and MCP73855, respectively.

TABLE 5-1: STATUS OUTPUTS – MCP73853

CHARGE CYCLE STATE	STAT1	STAT2
Qualification	OFF	OFF
Preconditioning	ON	OFF
Constant-current Fast Charge	ON	OFF
Constant-voltage	ON	OFF
Charge Complete	Flashing (1 Hz, 50% duty cycle)	OFF
Fault	OFF	ON
THERM Invalid	OFF	Flashing (1 Hz, 50% duty cycle)
Disabled - Sleep mode	OFF	OFF
Input Voltage Disconnected	OFF	OFF

Note: OFF state: open-drain is high-impedance; ON state: open-drain can sink current, typically 7 mA; FLASHING: toggles between OFF and ON states.

TABLE 5-2: STATUS OUTPUT – MCP73855

CHARGE CYCLE STATE	STAT1
Qualification	OFF
Preconditioning	ON
Constant Current Fast Charge	ON
Constant Voltage	ON
Charge Complete	OFF
Fault	Flashing (1Hz, 50% duty cycle)
THERM Invalid	Flashing (1Hz, 50% duty cycle)
Disabled - Sleep mode	OFF
Input Voltage Disconnected	OFF

Note: OFF state: open-drain is high impedance; ON state: open-drain can sink current, typically 7 mA; FLASHING: toggles between OFF state and ON state.

The flashing rate (1 Hz) is based off a timer capacitor (C_{TIMER}) of 0.1 µF. The rate will vary based on the value of the timer capacitor.

5.2.1.1 MCP73853 Only

STAT2 is on whenever the input voltage is above the under voltage lockout, the device is enabled, and all conditions are normal.

During a fault condition, the STAT1 status output will be off and the STAT2 status output will flash. To recover from a fault condition, the input voltage must be removed and then reapplied, or the enable input, EN, must be deasserted to a logic-low, then asserted to a logic-high.

When the voltage on the THERM input is outside the preset window, the charge cycle will either not start or be suspended. However, the charge cycle is not terminated, with recovery being automatic. The charge cycle will resume (or start) once the THERM input is valid and all other qualification parameters are met.

5.2.2 V_{SET} INPUT

The V_{SET} input selects the regulated output voltage of the MCP7385X devices. With V_{SET} tied to V_{SS}, the MCP7385X devices regulate to 4.1V. With V_{SET} tied to V_{DD}, the MCP7385X devices regulate to 4.2V.

5.2.3 LOGIC ENABLE (EN)

The logic enable input pin (EN) can be used to terminate a charge anytime during the charge cycle, initiate a charge cycle or initiate a recharge cycle.

Applying a logic-high input signal to the EN pin, or tying it to the input source, enables the device. Applying a logic-low input signal disables the device and terminates a charge cycle. When disabled, the device's supply current is reduced to 0.28 µA, typically.

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6.0 APPLICATIONS

The MCP7385X devices are designed to operate in conjunction with a host microcontroller or in stand-alone applications. The MCP7385X devices provide the preferred charge algorithm for Li-Ion/Li-Polymer cells, constant current followed by constant voltage. Figure 6-1 depicts a typical stand-alone application circuit, while Figures 6-2 and 6-3 depict the accompanying charge profile.

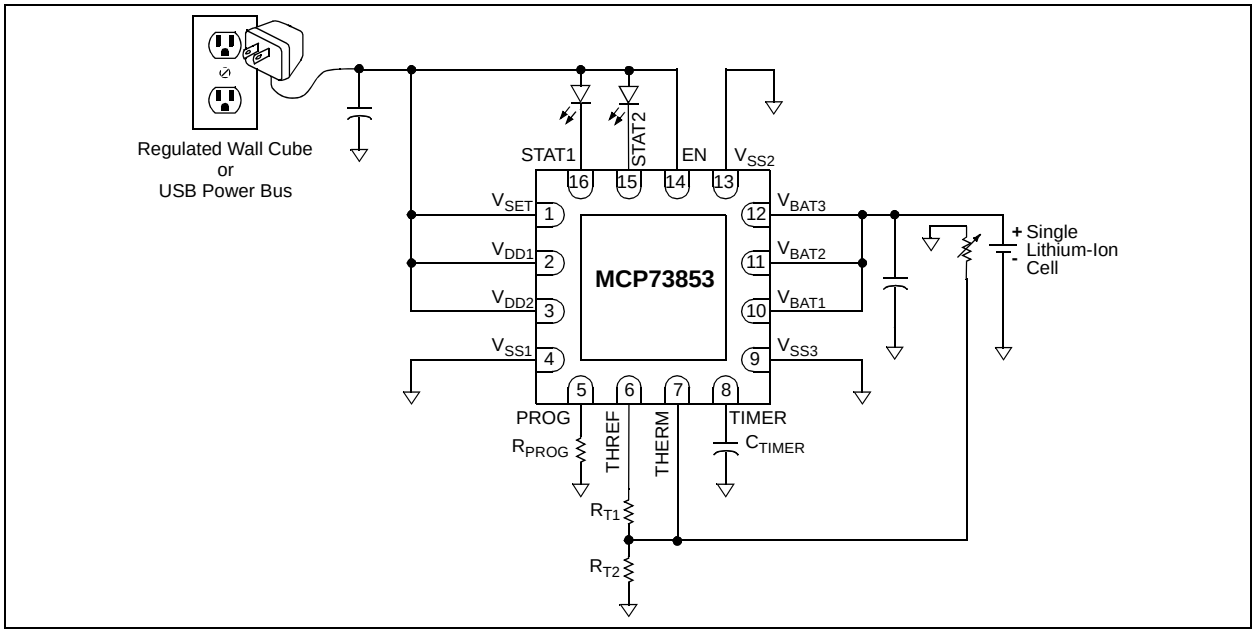

FIGURE 6-1: *Typical Application Circuit.*

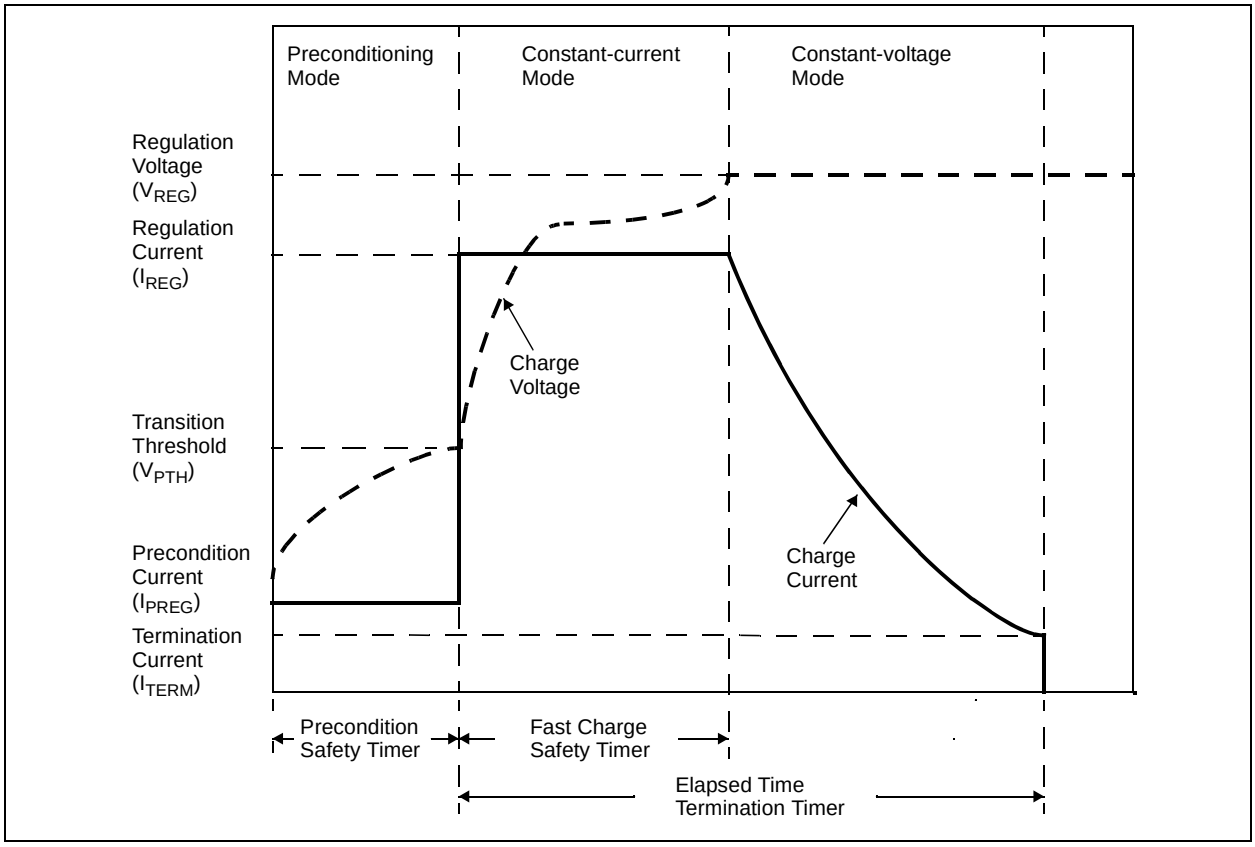

FIGURE 6-2: *Typical Charge Profile.*

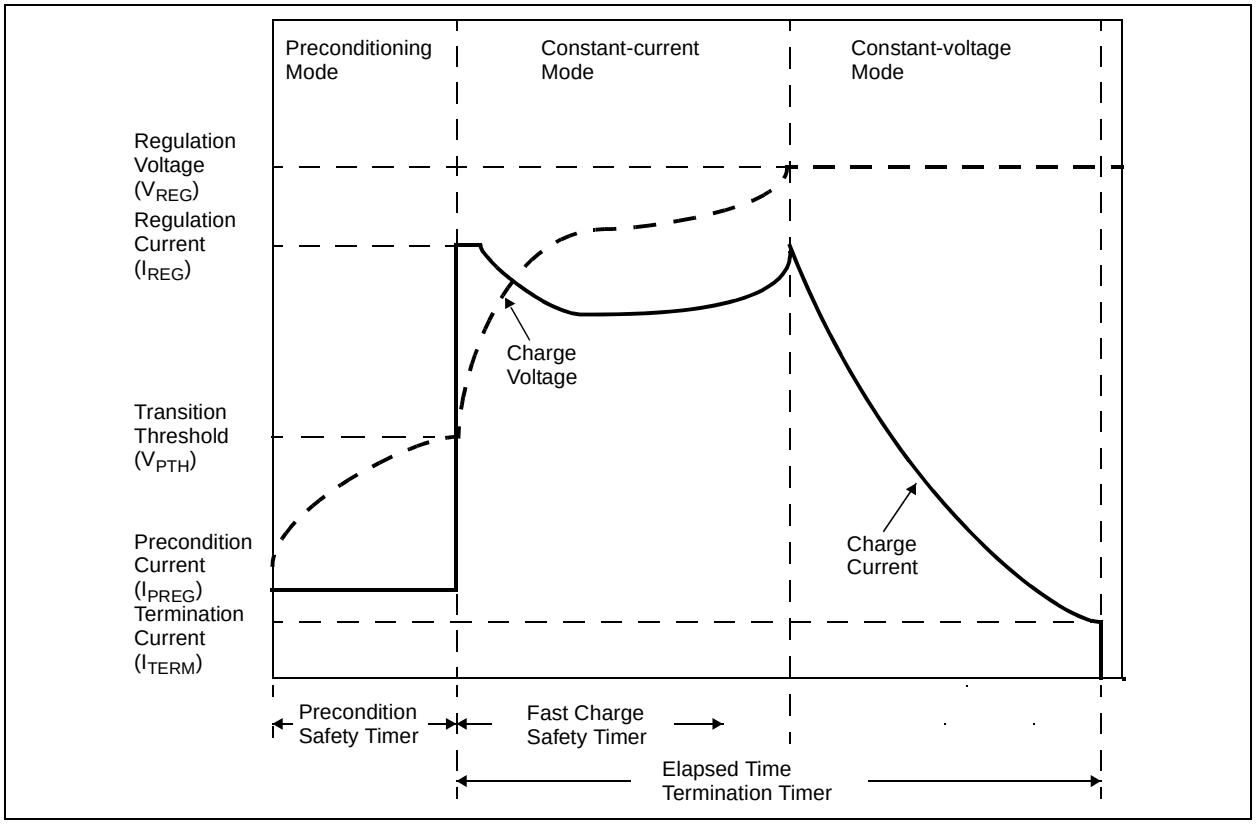

FIGURE 6-3: *Typical Charge Profile in Thermal Regulation.*

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6.1 Application Circuit Design

Due to the low efficiency of linear charging, the most important factors are thermal design and cost. These are a direct function of the input voltage, output current and thermal impedance between the battery charger and the ambient cooling air. The worst-case situation exists when the device has transitioned from the Preconditioning mode to the Constant-current mode. In this situation, the battery charger has to dissipate the maximum power. A trade-off must be made between the charge current, cost and thermal requirements of the charger.

6.1.1 COMPONENT SELECTION

Selection of the external components in Figure 6-1 is crucial to the integrity and reliability of the charging system. The following discussion is intended to be a guide for the component selection process.

6.1.1.1 CURRENT PROGRAMMING RESISTOR (R_{PROG})

The preferred fast charge current for Lithium-Ion cells is at the 1C rate, with an absolute maximum current at the 2C rate. For example, a 500 mAH battery pack has a preferred fast charge current of 500 mA. Charging at this rate provides the shortest charge cycle times without degradation to the battery pack performance or life.

400 mA is the typical maximum charge current obtainable from the MCP7385X devices. For this situation, the PROG input should be connected directly to V_{SS}.

6.1.1.2 THERMAL CONSIDERATIONS

The worst-case power dissipation in the battery charger occurs when the input voltage is at the maximum and the device has transitioned from the Preconditioning mode to the Constant-current mode. In this case, the power dissipation is:

$$PowerDissipation = (V_{DDMAX} - V_{PTHMIN}) \times I_{REGMAX}$$

Where V_{DDMAX} is the maximum input voltage (I_{REGMAX}) is the maximum fast charge current, and V_{PTHMIN} is the minimum transition threshold voltage. Power dissipation with a 5V, +/-10% input voltage source is:

$$PowerDissipation = (5.5V - 2.7V) \times 475mA = 1.33W$$

With the battery charger mounted on a 1 in^2 pad of 1 oz. copper, the junction temperature rise is approximately 50°C. This would allow for a maximum operating ambient temperature of 35°C before thermal regulation is entered.

6.1.1.3 EXTERNAL CAPACITORS

The MCP7385X devices are stable with or without a battery load. In order to maintain good AC stability in the Constant-voltage mode, a minimum capacitance of 4.7 µF is recommended to bypass the V_{BAT} pin to V_{SS}. This capacitance provides compensation when there is no battery load. In addition, the battery and interconnections appear inductive at high frequencies. These elements are in the control feedback loop during Constant-voltage mode. Therefore, the bypass capacitance may be necessary to compensate for the inductive nature of the battery pack.

Virtually any good quality output filter capacitor can be used, independent of the capacitor's minimum Effective Series Resistance (ESR) value. The actual value of the capacitor (and its associated ESR) depends on the output load current. A 4.7 µF ceramic, tantalum or aluminum electrolytic capacitor at the output is usually sufficient to ensure stability for up to the maximum output current.

6.1.1.4 REVERSE BLOCKING PROTECTION

The MCP7385X devices provide protection from a faulted or shorted input or from a reversed-polarity input source. Without the protection, a faulted or shorted input would discharge the battery pack through the body diode of the internal pass transistor.

6.1.1.5 ENABLE INTERFACE

In the stand-alone configuration, the enable pin is generally tied to the input voltage. The MCP7385X devices automatically enter a low power mode when voltage on the V_{DD} input falls below the UVLO voltage (V_{STOP}), reducing the battery drain current to 0.28 µA, typically.

6.1.1.6 CHARGE STATUS INTERFACE

Two status outputs provide information on the state of charge. The current-limited, open-drain outputs can be used to illuminate external LEDs. Refer to Table 5-1 and Table 5-2 for a summary of the state of the status output during a charge cycle.

6.2 PCB Layout Issues

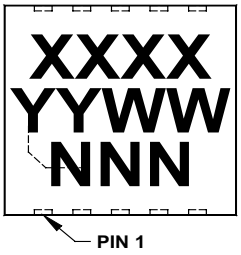
For optimum voltage regulation, place the battery pack as close as possible to the device's V_{BAT} and V_{SS} pins. It is recommended that the designer minimize voltage drops along the high-current-carrying PCB traces.

If the PCB layout is used as a heat sink, adding many vias in the heat sink pad can help conduct more heat to the backplane of the PCB, thus reducing the maximum junction temperature.

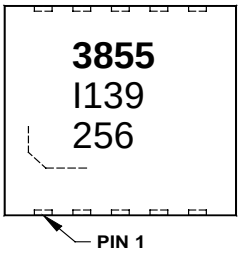
7.0 PACKAGING INFORMATION

7.1 Package Marking Information

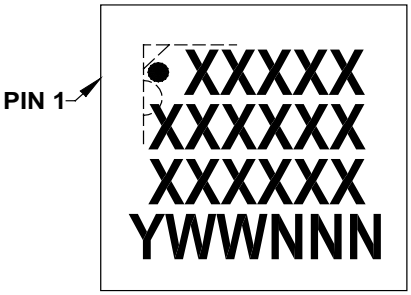
10-Lead DFN **(MCP73855)** (3x3x0.9 mm)



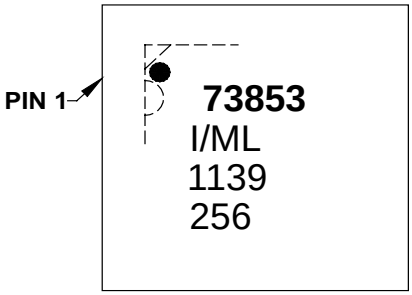
Example



16-Lead QFN **(MCP73853)**



Example



Legend:	XX...X	Customer specific information*
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week ‘01’)
	NNN	Alphanumeric traceability code
Note:	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.	

***** Standard OTP marking consists of Microchip part number, year code, week code, and traceability code.

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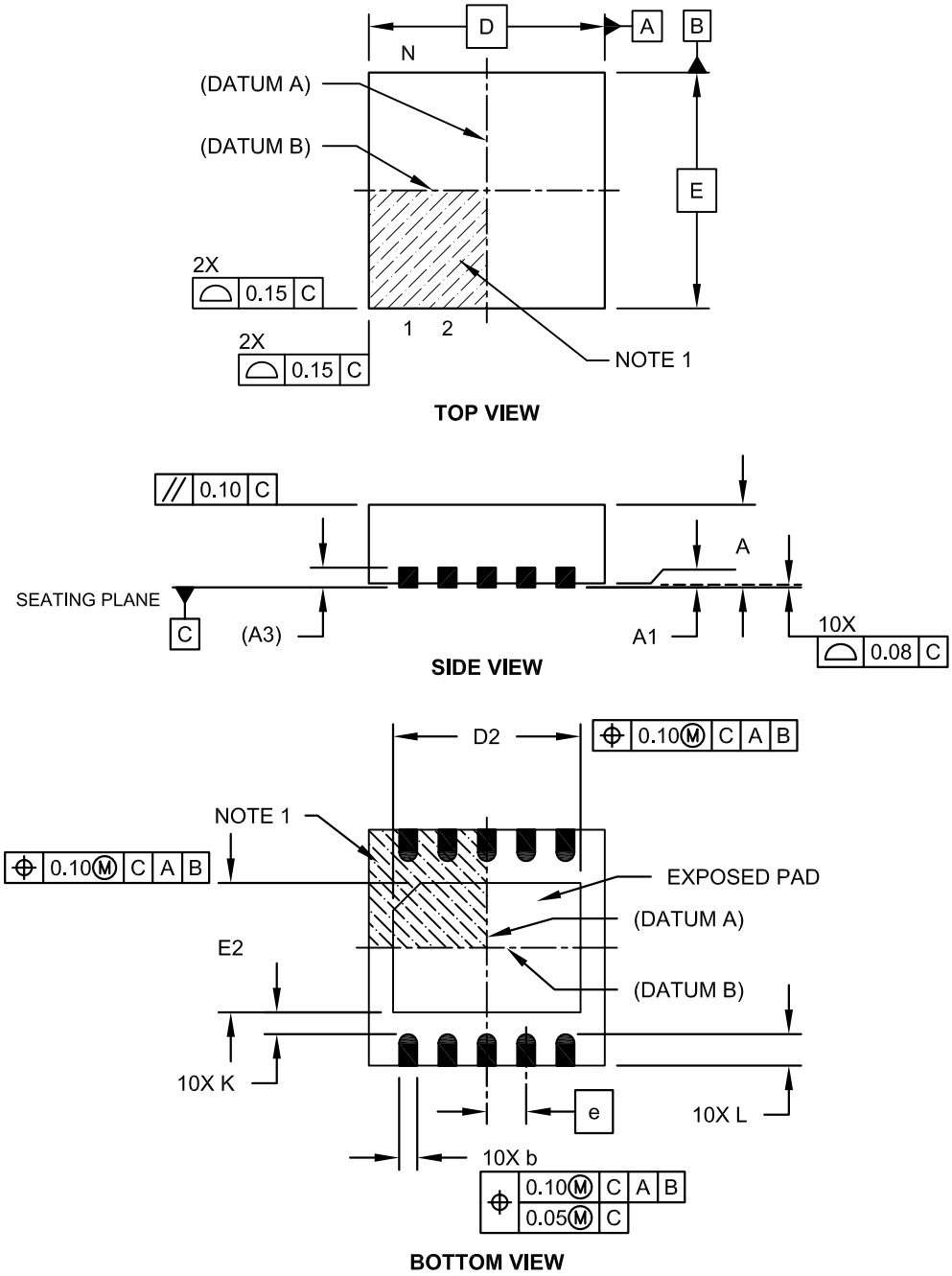
10-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

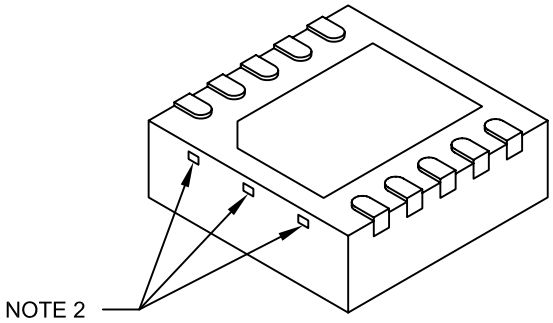
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-063C Sheet 1 of 2

10-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	10		
Pitch	e	0.50 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Length	D	3.00 BSC		
Exposed Pad Length	D2	2.15	2.35	2.45
Overall Width	E	3.00 BSC		
Exposed Pad Width	E2	1.40	1.50	1.75
Contact Width	b	0.18	0.25	0.30
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package may have one or more exposed tie bars at ends.
3. Package is saw singulated.
4. Dimensioning and tolerancing per ASME Y14.5M.
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-063C Sheet 2 of 2

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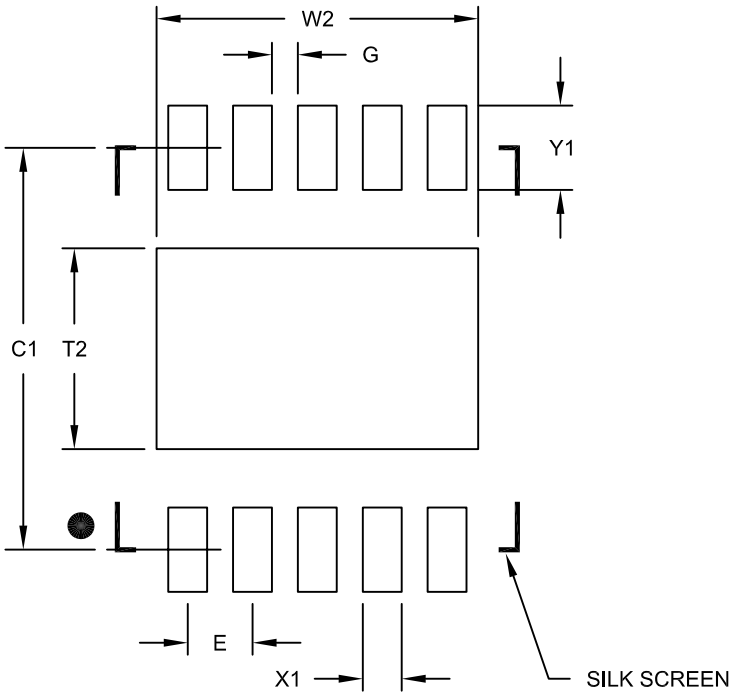
10-Lead Plastic Dual Flat, No Lead Package (MF) - 3x3x0.9mm Body [DFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.50 BSC		
Optional Center Pad Width	W2			2.48
Optional Center Pad Length	T2			1.55
Contact Pad Spacing	C1		3.10	
Contact Pad Width (X10)	X1			0.30
Contact Pad Length (X10)	Y1			0.65
Distance Between Pads	G	0.20		

Notes:

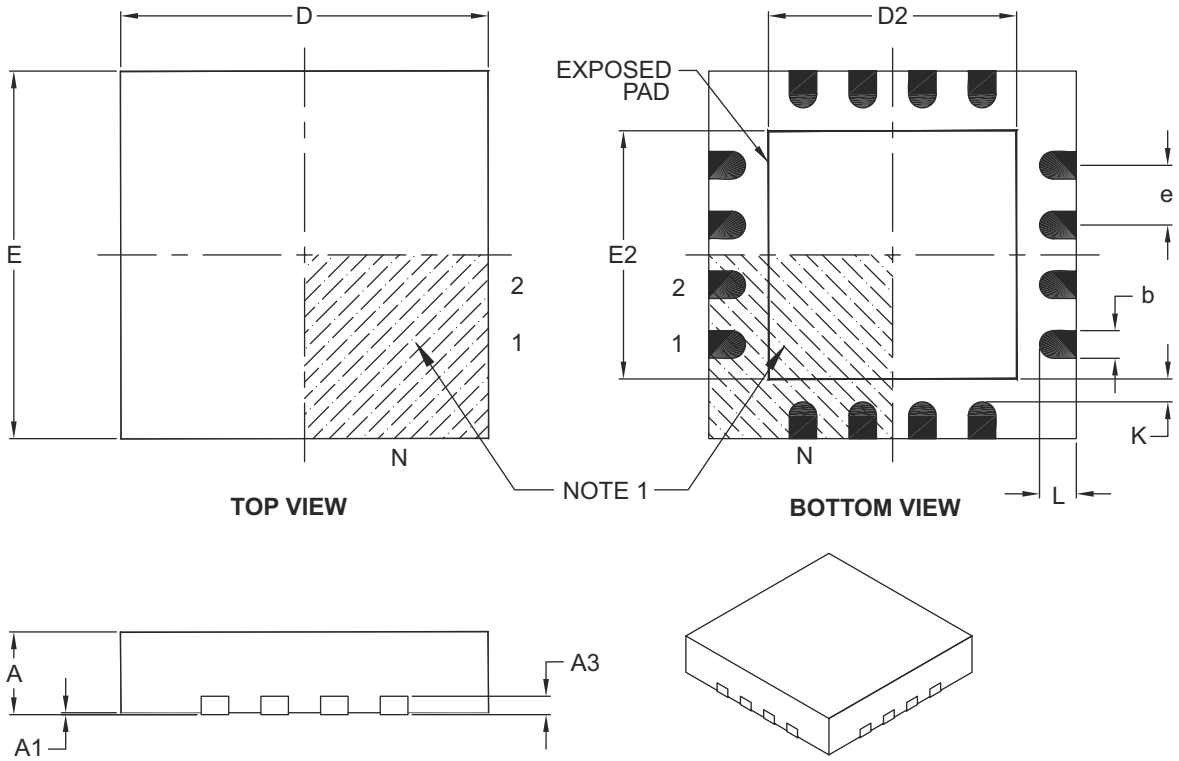
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2063B

16-Lead Plastic Quad Flat, No Lead Package (ML) – 4x4x0.9 mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N	16		
Pitch	e	0.65 BSC		
Overall Height	A	0.80	0.90	1.00
Standoff	A1	0.00	0.02	0.05
Contact Thickness	A3	0.20 REF		
Overall Width	E	4.00 BSC		
Exposed Pad Width	E2	2.50	2.65	2.80
Overall Length	D	4.00 BSC		
Exposed Pad Length	D2	2.50	2.65	2.80
Contact Width	b	0.25	0.30	0.35
Contact Length	L	0.30	0.40	0.50
Contact-to-Exposed Pad	K	0.20	–	–

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. Package is saw singulated.
3. Dimensioning and tolerancing per ASME Y14.5M.
   BSC: Basic Dimension. Theoretically exact value shown without tolerances.
   REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-127B

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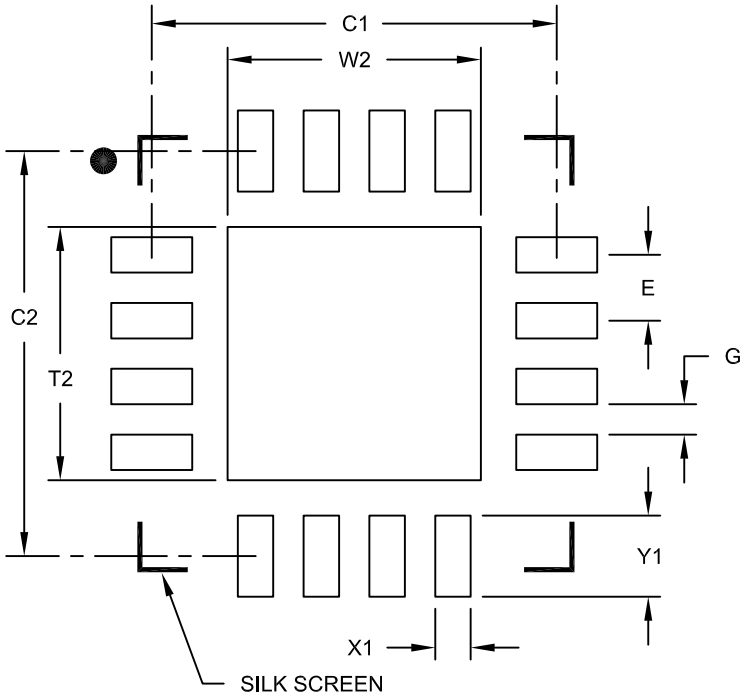
16-Lead Plastic Quad Flat, No Lead Package (ML) - 4x4x0.9mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			2.50
Optional Center Pad Length	T2			2.50
Contact Pad Spacing	C1		4.00	
Contact Pad Spacing	C2		4.00	
Contact Pad Width (X16)	X1			0.35
Contact Pad Length (X16)	Y1			0.80
Distance Between Pads	G	0.30		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2127A

APPENDIX A: REVISION HISTORY

Revision B (February 2012)

The following is the list of modifications:

1. Updated **Section 7.1 "Package Marking Information"**.

Revision A (November 2004)

- Original Release of this Document.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

PART NO.	X	XX
Device	Temperature Range	Package

Device	MCP73853:	USB compatible charge controller with temperature monitor
	MCP73853T:	USB compatible charge controller with temperature monitor, Tape and Reel
	MCP73855:	USB compatible charge controller
	MCP73855T:	USB compatible charge controller, Tape and Reel
Temperature Range	I =	-40°C to +85°C (Industrial)
Package	ML =	Plastic Quad Flat No Lead, 4x4 mm Body (QFN), 16-Lead
	MF =	Plastic Dual Flat No Lead, 3x3 mm Body (DFN), 10-Lead

Examples:

a)	MCP73853T-I/ML:	Tape and Reel, USB compatible charge controller with temperature monitor
b)	MCP73853-I/ML:	USB compatible charge controller with temperature monitor
a)	MCP73855T-I/MF:	Tape and Reel, USB compatible charge controller
b)	MCP73855-I/MF:	USB compatible charge controller

NOTES:

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Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
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